

L Number	Hits	Search Text	DB	Time stamp
3	13	((polyoxymethylene acetal polyacetal) with (backing core base substrate)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:21
4	117	(polyoxymethylene acetal polyacetal) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:45
6	1	JP-03243343-\$.DID.	DERWENT	2002/03/08 12:39
7	3	"03243343"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:41
8	47	((polyoxymethylene acetal polyacetal) with (polystyrene polyethylene)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:47
-	4	"5827788"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:15
-	4252	(decorat\$8 near5 sheet) and (floor\$6 wall\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:39
-	197	((decorat\$8 near5 sheet) same composite) and (floor\$6 wall\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:42
-	307	442/164.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:41
-	0	((decorat\$8 near5 sheet) and (floor\$6 wall\$9)) and 442/164.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:42
-	1	((decorat\$8 near5 sheet) same composite) and 442/164.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:43
-	3	(decorat\$8 near5 sheet) and 442/164.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:45
-	4588	(decorat\$8 near5 (composite sheet)) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:47

-	2291	(decorat\$8 near5 (composite sheet)) same (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:50
-	175	decorat\$8 same composite same sheet same (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 11:52
-	31	(decorat\$8 near5 composite near5 sheet) same (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 13:51
-	65	(decorat\$8 near5 composite near5 (panel sheet)) same (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 12:19
-	73	(decorat\$8 near5 composite near5 (panel sheet mo\$11d\$8)) same (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 13:48
-	12	"4706431"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 12:26
-	10	((decorat\$8 near5 composite near5 (panel sheet mo\$11d\$8)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 14:00
-	12	((decorat\$8 near5 composite near5 (panel sheet mo\$11d\$8 laminate)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 14:05
-	939	((decorat\$8 near5 (panel sheet mo\$11d\$8 laminate)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 14:09
-	205	((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:17
-	122	((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9) and thick\$8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 14:21
-	20	((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9) and (thick\$8 near5 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 17:07

-	0	(decorat\$8 near5 (composite laminate)) and ((heat thermal\$4) near5 (cur\$9 cross\$9) near5 protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 15:02
-	0	(decorat\$8 near5 composite near5 panel) and ((heat thermal\$4) near5 (cur\$9 cross\$9) near5 protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 15:09
-	20	"3378433"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/06 17:22
-	20	((polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and (decorat\$8 near5 (composite laminate)) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:23
-	3	((polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and ((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:22
-	85	((thermoplastic polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and (decorat\$8 near5 (composite laminate)) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:25
-	15	((thermoplastic polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and ((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 11:08
-	9	("3420021" "4052835" "4157756").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 10:45
-	5	((thermoplastic polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and (decorat\$8 near5 (composite laminate)) and (protect\$6 near5 (cross\$9 cur\$4 thermoset\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 11:17
-	70	((((thermoplastic polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and (decorat\$8 near5 (composite laminate)) and (wall\$9 floor\$9)) not (((thermoplastic polystyrene polyoxymethylene (polybutylene near3 terephthalate)) near7 (substrate backing core)) and ((decorat\$8 near5 (composite laminate)) same protect\$6) and (wall\$9 floor\$9))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/07 11:29
-	372	((filler talc chalk bead reinforcing) same (thermoplastic polystyrene polyethylene polyvinyl)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 09:50
-	14	polyoxymethylene and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 10:59

-	136	((filler talc chalk bead reinforcing) same (percent part weight) same (thermoplastic polystyrene polyethylene polyvinyl)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 09:53
-	53	((filler talc chalk bead reinforcing) same ((percent part) near5 weight) same (thermoplastic polystyrene polyethylene polyvinyl)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 09:57
-	26	((filler talc chalk bead reinforcing) near7 (percent part) near7 weight) same (thermoplastic polystyrene polyethylene polyvinyl)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 10:00
-	8	((filler talc chalk bead reinforcing) near7 (percent part) near7 weight) same (thermoplastic polystyrene polyethylene polyvinyl) same (backing core)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 10:01
-	1	((polyoxymethylene paraformaldehyde) near7 (backing core substrate)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 11:02
-	60	(polyoxymethylene paraformaldehyde) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:27
-	8	(polyoxymethylene paraformaldehyde) same (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 11:06
-	7	(polyoxymethylene acetal polyacetal) same (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 11:07
-	13	((polyoxymethylene acetal polyacetal) with (backing core base substrate)) and (decorative near5 (composite laminate structure))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/08 12:17